

APPLICATION DATA SHEET**Inventor Information**

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Application Information

Title : STRUCTURE AND METHOD FOR TRANSVERSE FIELD ENHANCEMENT
Total Drawing Sheets : 13
Formal Drawings : YES
Application Type : Utility
Attorney Docket Number : 500990.03 (30013/US/2)
Assigned : Yes (Large Entity)

Representative Information

Representative Customer No. : 27,076

Continuity Information

This application is a : divisional of
>Application One : 10/251,340
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which is a : divisional of
>>Application Two : 09/916,563
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